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General Description

The MAX7033 evaluation kit (EV kit) allows for a detailed evaluation of the MAX7033 superheterodyne receiver. It enables testing of the device's RF performance and requires no additional support circuitry. The RF input uses a 50Ω matching network and an SMA connector for convenient connection to test equipment. The EV kit can also directly interface to the user's embedded design for easy data decoding.

The MAX7033 EV kit comes in two versions: 315MHz and 433.92MHz. The passive components are optimized for these frequencies. These components can easily be changed to work at RF frequencies from 300MHz to 450MHz. In addition, the received data rate can be adjusted from 0 to 66kbps by changing three more components.

For easy implementation into the customer's design, the MAX7033 EV kit also features a proven PC board layout, which can be easily duplicated for quicker time to market. The EV kit Gerber files are available for download at www.maxim-ic.com.

Features

- ♦ Proven PC Board Layout
- ♦ Proven Components Parts List
- Multiple Test Points Provided On Board
- ◆ Available in 315MHz or 433.92MHz Optimized **Versions**
- ◆ Adjustable Frequency Range from 300MHz to 450MHz*
- ♦ Fully Assembled and Tested
- ♦ Can Operate as a Stand-Alone Receiver with the **Addition of an Antenna**

Ordering Information

PART	TEMP RANGE	IC PACKAGE
MAX7033EVKIT-315	-40°C to +85°C	28 TSSOP
MAX7033EVKIT-433	-40°C to +85°C	28 TSSOP

Component List

DESIGNATION	QTY	DESCRIPTION
C1, C2, C23	2	0.01µF ±10% ceramic capacitors (0603) Murata GRM188R71H103KA01
C3	1	1500pF±10%, 50V X7R ceramic capacitor (0603) Murata GRM188R71H152KA01
C4	1	0.47µF 80% to 20% ceramic capacitor (0603) Murata GRM188F51C474ZA01
C5	1	470pF ±5% ceramic capacitor (0603) Murata GRM1885C1H471JA01
C6, C10	2	220pF ±5% ceramic capacitors (0603) Murata GRM1885C1H221JA01
C7, C8, C11	3	100pF ±5% ceramic capacitors (0603) Murata GRM1885C1H101JA01
C9 (315MHz)	1	4.0pF ±0.1pF ceramic capacitor (0603) Murata GRM1885C1H4R0BZ01
C9 (433MHz)	1	2.2pF ±0.1pF ceramic capacitor (0603) Murata GRM1885C1H2R2BD01

DESIGNATION	QTY	DESCRIPTION
C12, C20, C24	2	0.1µF ±5% ceramic capacitors (0603) Murata GRM188R71C104KA01
C13, C16, C18, C19	0	Not installed
C14, C15	2	15pF ±5%, 50V ceramic capacitors (0603) Murata GRM1885C1H150JZ01
C17	0	Not installed, 0.01µF 80% to 20% ceramic capacitor (0603) Murata GRM188R71H103KA01
C21	1	10pF ±5%, 50V ceramic capacitor (0603) Murata GRM1885C1H100JZ01
C22	1	1000pF ±10%, 50V X7R ceramic capacitor (0603) Murata GRM188R71H102KA01
F_IN	0	Not installed, SMA connector, edge mount Johnson 142-0701-801
JU1, JU2, JU5, JU6	4	3-pin headers Digi-Key S1012-36-ND or equivalent

^{*}Requires component changes.

Component List (continued)

DESIGNATION	QTY	DESCRIPTION
JU3, JU4	0	Not installed
JU7	1	2-pin header
JU8	1	Shorted
L1 (315MHz)	1	27nH ±5% inductor (0603) Coilcraft 0603CS-27NXJB
L1 (433MHz)	1	15nH ±5% inductor (0603) Coilcraft 0603CS-15NXJB
L2 (315MHz)	1	120nH ±5% inductor (0603) Coilcraft 0603CS-R12XJB
L2 (433MHz)	1	56nH ±5% inductor (0603) Coilcraft 0603CS-56NXJB
L3	1	15nH ±5% inductor (0603) Murata LQG18HN15NJ00
MIX_OUT	0	Not installed, SMA connector, top mount Digi-Key J500-ND Johnson 142-0701-201
R1	1	5.1kΩ resistor (0603), any
R2, R4, R6	0	Not installed, resistors (0603)
R3	0	Not installed, 270Ω resistor (0603) any
R5	1	10kΩ resistor (0603), any

Quick Start

The following procedures allow for proper device evaluation.

Required Test Equipment

- Regulated power supply capable of providing +3.3V
- RF signal generator capable of delivering from -120dBm to 0dBm of output power at the operating frequency, in addition to AM or pulse-modulation capabilities (Agilent E4420B or equivalent)
- Optional ammeter for measuring supply current
- Oscilloscope

Connections and Setup

This section provides a step-by-step guide to operating the EV kit and testing the device's functionality. **Do not turn on the DC power or RF signal generator until all connections are made:**

 Connect a DC supply set to +3.3V (through an ammeter if desired) to the VDD and GND terminals on the EV kit. Do not turn on the supply.

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DESIGNATION	QTY	DESCRIPTION
R7	1	0Ω resistor (0603)
R8	1	10 k Ω resistor (0603), any
RF_IN	1	SMA connector, top mount Digi-Key J500-ND Johnson 142-0701-201
TP2, TP4-TP12	0	Not installed
VDD, GND, SHDN, AGC_C, DATA_OUT, TP3	6	Test points Mouser 151-203 or equivalent
Y1 (315MHz)	1	4.754687MHz crystal Hong Kong Crystals SSL4754687E03FAFZ8A0 or Crystek 016867
Y1 (433MHz)	1	6.6128MHz crystal Hong Kong Crystals SSL6612813E03FAFZ8A0 or Crystek 016868
Y2	1	10.7MHz ceramic filter Murata SFTLA10M7FA00-B0
U1	1	MAX7033EUI
	1	MAX7033 EV kit PC board
_	5	Shunts (JU1) Digi-Key S9000-ND or equivalent

- 2) Connect the RF signal generator to the RF_IN SMA connector. Do not turn on the generator output. Set the generator for an output frequency of 315MHz (or 433.92MHz) at a power level of -100dBm. Set the modulation of the generator to provide a 2kHz, 100%, AM-modulated square wave (or a 2kHz pulse-modulated signal).
- 3) Connect the oscilloscope to test point TP3.
- 4) Turn on the DC supply. The supply current should read approximately 5mA.
- 5) Activate the RF generator's output without modulation. The scope should display a DC voltage that varies from approximately 1.2V to 2.0V as the RF generator amplitude is changed from -115dBm to 0dBm. (**Note:** At an amplitude of around -60dBm, this DC voltage drops suddenly to approximately 1.5V and then starts rising again with increasing input amplitude. This is normal; the AGC is turning on the LNA gain-reduction resistor.)
- 6) Set the RF generator to -100dBm. Activate the RF generator's modulation and set the scope's cou-

Component Suppliers

SUPPLIER	PHONE	FAX
Coilcraft	800-322-2645	847-639-1469
Crystek	800-237-3061	941-561-1025
Hong Kong Crystal	852-2412 0121	852-2498 5908
Murata	800-831-9172	814-238-0490

Note: Indicate that you are using the MAX7033 when contacting these component suppliers.

pling to AC. The scope now displays a lowpass-filtered square wave at TP3 (filtered analog baseband data). Use the RF generator's LF OUTPUT (modulation output) to trigger the oscilloscope.

 Monitor the DATA_OUT terminal and verify the presence of a 2kHz square wave.

Additional Evaluation

- With the modulation still set to AM, observe the effect of reducing the RF generator's amplitude on the DATA_OUT terminal output. The error in this sliced digital signal increases with reduced RF signal level. The sensitivity is usually defined as the point at which the error in interpreting the data (by the following embedded circuitry) increases beyond a set limit (BER test).
- 2) With the above settings, a 315MHz-tuned EV kit should display a sensitivity of about -114dBm (0.2% BER) while a 433.92MHz kit displays a sensitivity of about -112dBm (0.2% BER). **Note:** The above sensitivity values are given in terms of average.
- 3) Capacitors C5 and C6 are used to set the corner frequency of the 2nd-order lowpass Sallen-Key data filter. The current values were selected for bit rates up to 3kbps. Adjusting these values accommodates higher data rates (refer to the MAX7033 data sheet for more details).

Layout Issues

A properly designed PC board is an essential part of any RF/microwave circuit. On high-frequency inputs and outputs, use controlled-impedance lines and keep them as short as possible to minimize losses and radiation. At high frequencies, trace lengths that are on the order of $\lambda/10$ or longer can act as antennas.

Keeping the traces short also reduces parasitic inductance. Generally, 1in of a PC board trace adds about 20nH of parasitic inductance. The parasitic inductance can have a dramatic effect on the effective inductance. For example, a 0.5in trace connecting a 100nH inductor adds an extra 10nH of inductance or 10%.

To reduce the parasitic inductance, use wider traces and a solid ground or power plane below the signal traces. Also, use low-inductance connections to ground on all GND pins, and place decoupling capacitors close to all VDD connections.

The EV kit PC board can serve as a reference design for laying out a board using the MAX7033. All required components have been enclosed in 1.25in x 1.25in², which can be directly "inserted" in the application circuit.

Detailed Description

Power-Down Control

The MAX7033 can be controlled externally using the SHDN connector. The IC draws approximately 2.5µA in shutdown mode. Jumper JU1 is used to control this mode. The shunt can be placed between pins 2 and 3 for continuous shutdown, or pins 1 and 2 for continuous operation. Remove JU1 shunt for external control. See Table 1 for the jumper function descriptions.

Table 1. Jumper Function

JUMPER	STATE	FUNCTION
	1-2	Normal operation
JU1	2-3	Power-down mode
	N.C.	External power-down control
JU2	1-2	Crystal divide ratio = 32
JU2	2-3	Crystal divide ratio = 64
	1-2	Mixer output to MIX_OUT
JU3	2-3	External IF input
	N.C.	Normal operation
JU4	1-2	Uses PDOUT for faster receiver startup
304	2-3	GND connection for peak detector filter
	1-2	Disable AGC
JU5	2-3	Enable AGC
	N.C.	External control of AGC lock function
	1-2	IR centered at 433MHz
JU6	2-3	IR centered at 315MHz
	N.C.	IR centered at 375MHz
JU7	1-2	Connect VDD to +3.3V supply
307	N.C.	Connect VDD to +5.0V supply

Power Supply

The MAX7033 can operate from 3.3V or 5V supplies. For 5V operation, remove JU7 before connecting the supply to VDD. For 3.3V operation, connect JU7.

IF Input/Output

The 10.7MHz IF can be monitored with the help of a spectrum analyzer using the MIX_OUT SMA (not provided). Remove the ceramic filter for such a measurement and include R3 (270 Ω) and C17 (0.01 μ F) to match the 330 Ω mixer output with the 50 Ω spectrum analyzer. Jumper JU3 needs to connect pins 1 and 2. It is also possible to use the MIX_OUT SMA to inject an external IF as a means of evaluating the baseband data slicing section. Jumper JU3 needs to connect pins 2 and 3.

F_IN External Frequency Input

For applications where the correct frequency crystal is not available, it is possible to directly inject an external frequency through the F_IN SMA (not provided). Connect the SMA to a function generator. The addition of C18 and C19 is necessary (use 0.01µF capacitors).

AGC Control

Jumper JU5 controls whether the AGC is enabled. Connect pins 2 and 3 to enable the AGC. In addition, by removing the jumper, the AGC setting can be locked or unlocked by transitioning the AC pin while the SHDN pin is high.

Crystal Select

Jumper JU2 controls the crystal-divide ratio. Connecting pins 1 and 2 sets the divide ratio to 32, while connecting pins 2 and 3 sets the ratio to 64. This determines the frequency of the crystal to be used.

Image-Rejection Frequency Select

A unique feature of the MAX7033 is its ability to vary at which frequency the image rejection is optimized. JU6 allows the selection of three possible frequencies: 315MHz, 375MHz, and 433.92MHz. See Table 1 for settings.

Test Points and I/O Connections

Additional test points and I/O connectors are provided to monitor the various baseband signals and for external connections. See Tables 2 and 3 for a description.

For additional information and a list of application notes, visit www.maxim-ic.com.

Table 2. Test Points

TP	DESCRIPTION
2	Data slicer negative input
3	Data filter output
4	Peak detector out
5	+3.3V
6	GND
7	Data filter feedback node
8	Data out
9	Power-down select input
10	VDD
11	AGC control
12	Crystal select

Table 3. I/O Connectors

SIGNAL	DESCRIPTION
RF_IN	RF input
F_IN	External reference frequency input
MIX_OUT	IF input/output
GND	Ground
VDD	Supply input
DATA_OUT	Sliced data output
SHDN	External power-down control
AGC_C	AGC control

Figure 1. MAX7033 EV Kit Schematic AT 433.92MHz 2.2pF 15nH 56nH C9 4pF L1 27nH L2 120nH Y1 4.75687MHz C14 15pF C15 15pF C19 OPEN F_IN 6.6128MHz C16 OPEN C18 I VDD 1 JU1 0 2 XTAL1 XTAL2 ▲ +3.3V SHDN SHDI 93 C12 L2 0.1µF PD0U1 U1 RF_IN 100pF NIXIN ₹R2 OPEN C13 OPEN MAX7033 20 JU4 0 3 = 1 LNASRC AGND C9 +3.3V R5 10kΩ Ŧ TP8 Q DATA_OUT DATAOUT LNAOUT ▲+3.3V VDD C2 0.01μF C11 100pF $V_{DD}5$ _____ C23 _____ 0.01μF C24 0.1μF C21 10pF L1 MIXIN1 ▲+3.3V R7 0Ω MIXIN2 C10 1220pF DSP C8 100pF C22 1000pF JU8 R6 OPEN +3.3V 0 2 3 0 JU6 GND • = 11 ►O TP7 DFFB IRSEL C6 220pF ____ C5 470pF OPI VDD O O JU7 DSN -0 _ C20 TP5 ____0.1μF TP10 MIXOUT DFC ⊐ _{R8} 10kΩ ∕√√√ DGND C3 1500pF ▲+3.3V DV_DD IFIN2 C1 0.01μF IFIN1 C17 OPEN R3 OPEN MIX_OUT XTALSEL 3 6 2 1 Q JU3 JU2¹ 0 2 3 0 = AGC_C TP12 O-+3.3V OPEN 1 0 2 3 0 JU5 TP11 O-Y2 10.7MHz 1 2 3

MAX7033 Evaluation Kit

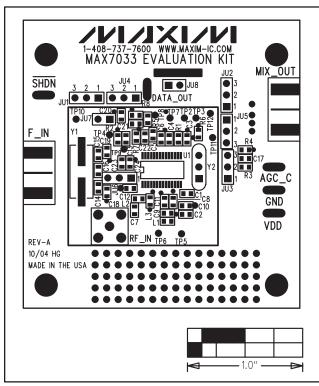


Figure 2. MAX7033 EV Kit Component Placement Guide—Component Side

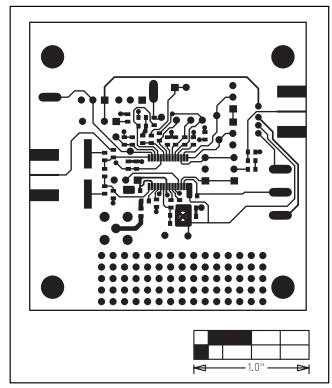


Figure 3. MAX7033 EV Kit PC Board Layout—Component Side

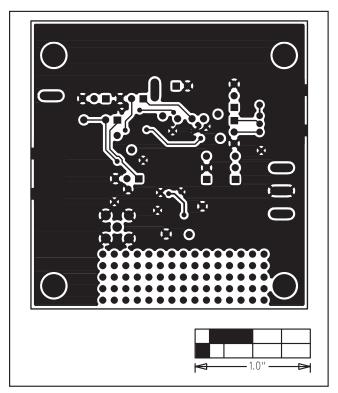


Figure 4. MAX7033 EV Kit PC Board Layout—Solder Side